

	HEATSINK TYPE	P/N HEATSINK ONLY	P/N HEATSINK W/ TIM ONLY	P/N HEATSINK, TIM AND GROUND TAB	P/N HEATSINK W/GROUND TAB ONLY
SOLDERING METHOD (SEE NOTE 2)	1ETHOD - 2(B)		2(A) HAND SOLDER ONLY	2(A) HAND SOLDER ONLY	2(B) WITH VICOR 40325 THERMAL GEL
2322	XF 11MM	39966	40488	40138	40478
	LF 11MM	39965	40489	40142	40479
3623	XF 11MM	39968	40490	40139	40480
	LF 11MM	39967	40491	40143	40481

DRAWN BY DATE				AAA VICO	OR .	SWD
Robert Wasik 7/22/2013				<u>'\\\</u>		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE: INCH / [MM]  TOLERANCES ARE: DECIMALS ANGLES  X.XX [X.X] = ±0.01 [0.25] ±1°  X.XXX [X.XX] = ±0.005 [0.127]	APP DWG, CHIP PUSHPIN TOPSIDE HS, 3623, 2322					
THIRD ANGLE PROJECTION	SIZE	CAGE CO	DE	DWG NO		REV
	D	6713	1 40112		<b>40112</b>	3
DO NOT SCALE DRAWING	SCALE	SCALE 2:1		SHEET 1 OF 1		

BLUE

GRAY

32436

32437

2.337 MM TO 3.023 MM

[.092"] TO [.119"]

3.048 MM TO 3.607 MM

[.120"] TO [.142"]

2.083 MM

[.082"]

2.743 MM

[.108"]

3.353 MM

[.132"]

3.988 MM

[.157"]

AND THEN WAVE-SOLDER ALL PINS.

LIMIT OF 3.1 LBF (13.8 N) PER PUSH-PIN.

4. ROHS COMPLIANT PER CST-0001 LATEST REVISION.

REMOVE FIXTURE AND, WHILE SUPPORTING PCB, INSERT PLASTIC PUSH-PINS THROUGH HEATSINK

INSTALLATION AS THIS WOULD EXPOSE THE CHIP TO FORCES GREATER THAN THE RECOMMENDED

AND PCB. (SELECT PROPER PUSH-PIN LENGTH FROM TABLE ON THIS DRAWING.)

3. CARE SHOULD BE TAKEN TO AVOID FULLY COMPRESSING THE PUSH-PIN SPRING DURING